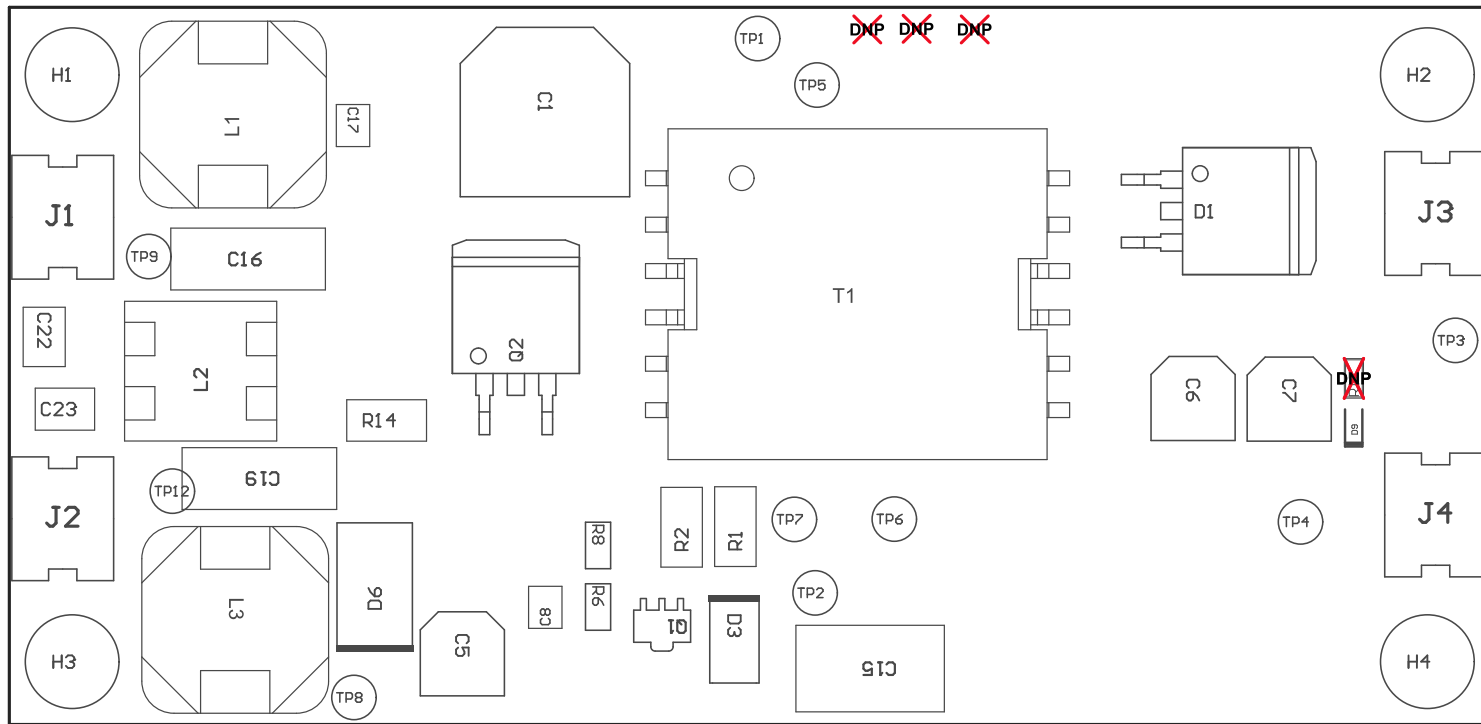


ZZ1 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

ZZ2 ■ This Assembly Note will show in the PcbDoc and associated outputs

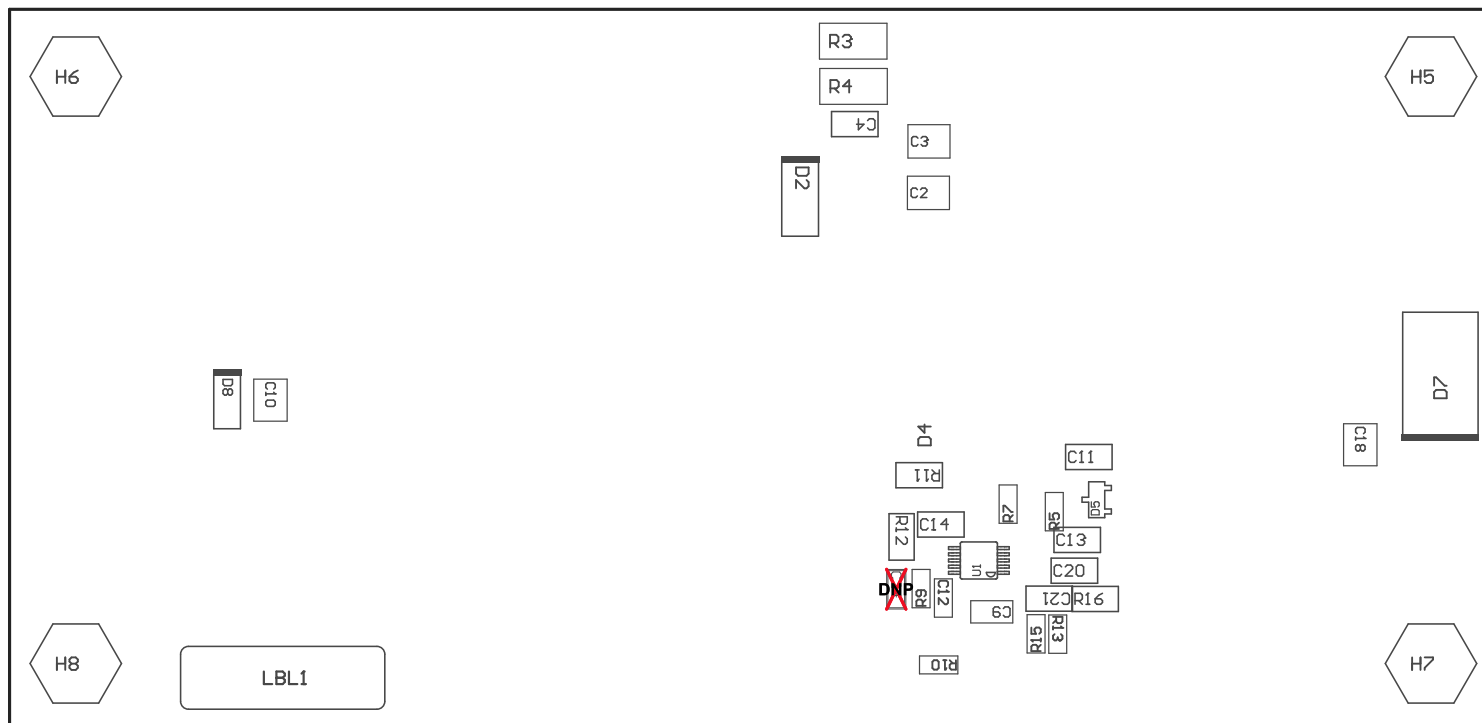
ZZ3 ■ This Assembly Note will show in the PcbDoc and associated outputs

ZZ4 ■ This Assembly Note will show in the PcbDoc and associated outputs



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01344	REV: E1	SUN REV: Not In VersionControl
	TID #: 1344		
PLOT NAME = Top Assembly Drawing	GENERATED : 12/16/2016 3:28:02 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01344	REV: E1	SUN REV: Not In VersionControl
	TID #: 1344		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/16/2016 3:28:07 PM	TEXAS INSTRUMENTS	

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